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Attorney Docket No. 23537.15

2152

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application:

Serial No.: 09/529,792

Filed: April 18, 2000

#7/Cheng  
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Technology Center 2100

July 24, 2002

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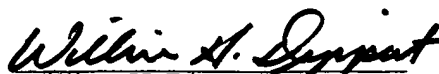
SIR:

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